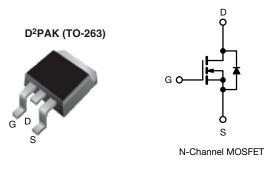
**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.82			
Q <sub>g</sub> max. (nC)	44				
Q <sub>gs</sub> (nC)	5				
Q <sub>gd</sub> (nC)	8				
Configuration	Single				

#### FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	D <sup>2</sup> PAK (TO-263)
Lead (Pb)-free and halogen-free	SiHB6N80E-GE3

<b>ABSOLUTE MAXIMUM RATINGS (T</b> <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	800	N/	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	5.4		
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		3.4	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	15		
Linear derating factor				0.63	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	95		
Maximum power dissipation			P <sub>D</sub>	78		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	T <sub>J</sub> = 125 °C		du /dt	70	V/ma	
Reverse diode dv/dt <sup>d</sup>		dv/dt	0.25	V/ns		
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s			300	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 2.6 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62		°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 1.6				C/W		
SPECIFICATIONS (T <sub>J</sub> = 25 $^{\circ}$ C, u	Inless otherwi	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITIO	ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 25	60 μA	800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I	<sub>D</sub> = 1 mA	-	1.1	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 28	50 µA	2.0	-	4.0	V
Gate-source leakage			$V_{GS} = \pm 20 V$			-	± 100	nA
Gate-source leakage	GSS	, N	V <sub>GS</sub> = ± 30 V	,	-	-	± 1	μA
Zara gata valtaga drain aurrant	la	V <sub>DS</sub> =	800 V, V <sub>GS</sub>	= 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub>	= 3 A	-	0.82	0.94	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 3 A		-	2.5	-	S	
Dynamic					•	•	•	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	827	-	-	
Output capacitance	C <sub>oss</sub>			-	37	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	24	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	109	-		
Total gate charge	Qg				-	22	44	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 3 A,	A, V <sub>DS</sub> = 480 V	-	5	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	8	-	
Turn-on delay time	t <sub>d(on)</sub>		•		-	13	26	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 3 A,		-	9	18	1
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	27	54	ns	
Fall time	t <sub>f</sub>			-	18	36		
Gate input resistance	Rg	f = 1 MHz, open drain			0.5	1.0	2.0	Ω
Drain-Source Body Diode Characteristic	÷							
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET symbol showing the		-	-	5.4		
Pulsed diode forward current	I <sub>SM</sub>	p - n junction diode			-	-	15	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V			-	-	1.2	V
-					1	1	1	<u> </u>

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 

t<sub>rr</sub>

Q<sub>rr</sub>

I<sub>RRM</sub>

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 V to 480 V VDSS

Reverse recovery time

Reverse recovery charge

Reverse recovery current

 $\begin{array}{l} T_J=25~^\circ C,~I_F=I_S=3~A,\\ di/dt=100~A/\mu s,~V_R=25~V \end{array}$ 

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2.0

11

\_

-

-

564

4.0

-

ns

μC

А



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

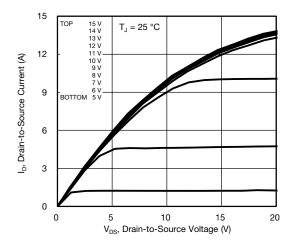
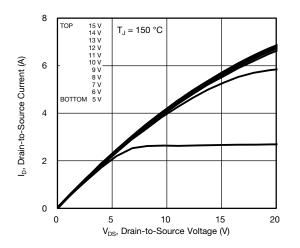


Fig. 1 - Typical Output Characteristics





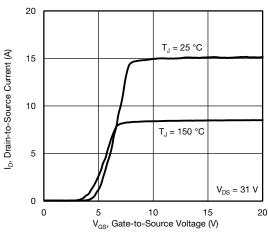


Fig. 3 - Typical Transfer Characteristics

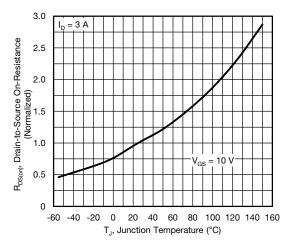


Fig. 4 - Normalized On-Resistance vs. Temperature

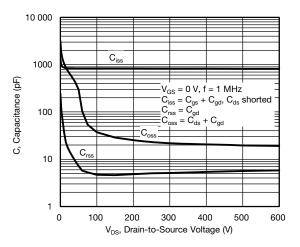


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

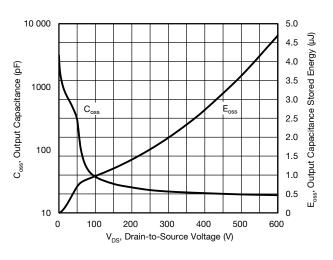


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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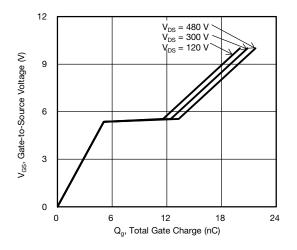


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

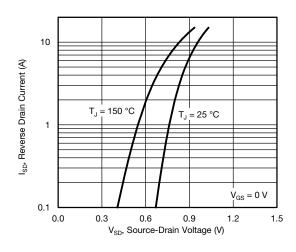


Fig. 8 - Typical Source-Drain Diode Forward Voltage

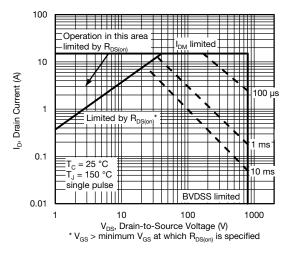


Fig. 9 - Maximum Safe Operating Area

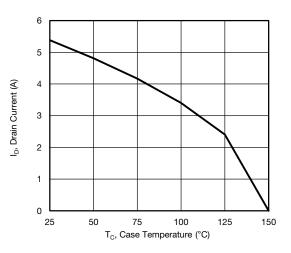


Fig. 10 - Maximum Drain Current vs. Case Temperature

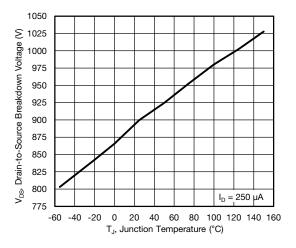


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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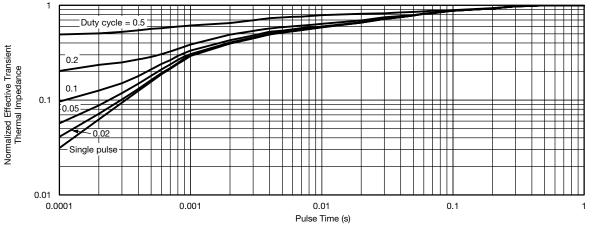


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

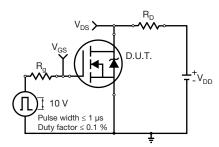


Fig. 13 - Switching Time Test Circuit

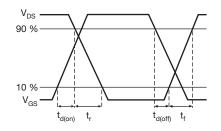


Fig. 14 - Switching Time Waveforms

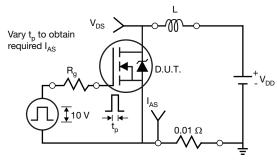


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

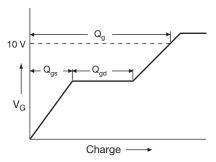


Fig. 17 - Basic Gate Charge Waveform

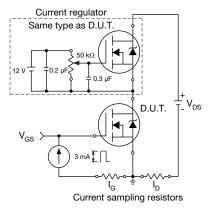


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

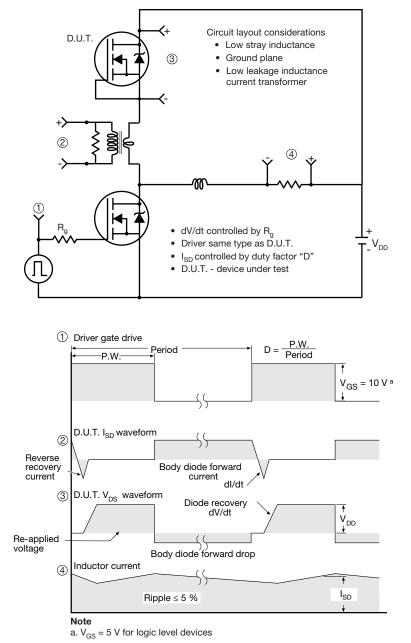


Fig. 19 - For N-Channel

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